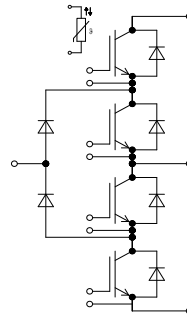
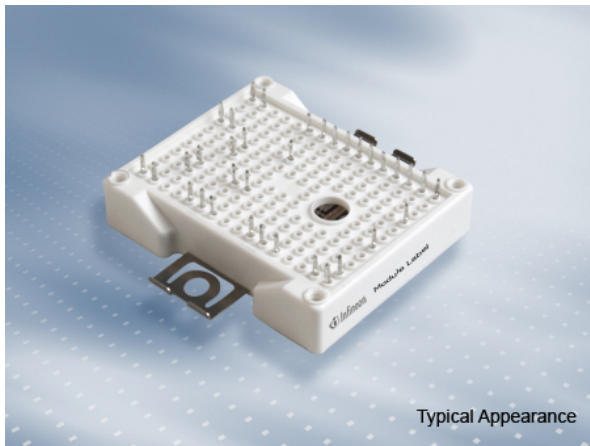


EasyPACK™ Modul mit TRENCHSTOP™ 5 und CoolSiC™ Schottky Diode und PressFIT / NTC  
 EasyPACK™ module with TRENCHSTOP™ 5 and CoolSiC™ Schottky diode and PressFIT / NTC



$V_{CES} = 650V$

$I_{C\ nom} = 100A / I_{CRM} = 200A$

### Potentielle Anwendungen

- 3-Level-Applikationen
- Motorantriebe
- Solar Anwendungen
- USV-Systeme

### Elektrische Eigenschaften

- CoolSiC™ Schottky Diode Gen 5
- Erhöhte Sperrspannungsfestigkeit auf 650V
- Niedrige Schaltverluste

### Mechanische Eigenschaften

- $Al_2O_3$  Substrat mit kleinem thermischen Widerstand
- Kompaktes Design
- PressFIT Verbindungstechnik
- Robuste Montage durch integrierte Befestigungsklammern

### Potential Applications

- 3-level-applications
- Motor drives
- Solar applications
- UPS systems

### Electrical Features

- CoolSiC™ Schottky diode gen 5
- Increased blocking voltage capability up to 650V
- Low switching losses

### Mechanical Features

- $Al_2O_3$  substrate with low thermal resistance
- Compact design
- PressFIT contact technology
- Rugged mounting due to integrated mounting clamps

## Module Label Code

Barcode Code 128



DMX - Code



### Content of the Code

| Content of the Code        | Digit   |
|----------------------------|---------|
| Module Serial Number       | 1 - 5   |
| Module Material Number     | 6 - 11  |
| Production Order Number    | 12 - 19 |
| Datecode (Production Year) | 20 - 21 |
| Datecode (Production Week) | 22 - 23 |

**IGBT, T1 / T4 / IGBT, T1 / T4****Höchstzulässige Werte / Maximum Rated Values**

|                                                                          |                                                              |           |       |   |
|--------------------------------------------------------------------------|--------------------------------------------------------------|-----------|-------|---|
| Kollektor-Emitter-Sperrspannung<br>Collector-emitter voltage             | $T_{vj} = 25^{\circ}\text{C}$                                | $V_{CES}$ | 650   | V |
| Implementierter Kollektor-Strom<br>Implemented collector current         |                                                              | $I_{CN}$  | 200   | A |
| Kollektor-Dauergleichstrom<br>Continuous DC collector current            | $T_H = 65^{\circ}\text{C}, T_{vj\max} = 175^{\circ}\text{C}$ | $I_{CDC}$ | 95    | A |
| Periodischer Kollektor-Spitzenstrom<br>Repetitive peak collector current | $t_P = 1\text{ ms}$                                          | $I_{CRM}$ | 400   | A |
| Gate-Emitter-Spitzenspannung<br>Gate-emitter peak voltage                |                                                              | $V_{GES}$ | +/-20 | V |

**Charakteristische Werte / Characteristic Values**

|                                                                                  |                                                                                                                                                                                                               |                                                                                                   | min.                | typ.                    | max. |                                                 |
|----------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------|---------------------|-------------------------|------|-------------------------------------------------|
| Kollektor-Emitter-Sättigungsspannung<br>Collector-emitter saturation voltage     | $I_C = 100\text{ A}$<br>$V_{GE} = 15\text{ V}$                                                                                                                                                                | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $V_{CE\text{ sat}}$ | 1,17<br>1,20<br>1,21    | 1,38 | V<br>V<br>V                                     |
| Gate-Schwellenspannung<br>Gate threshold voltage                                 | $I_C = 2,00\text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$                                                                                                                                          |                                                                                                   | $V_{G\text{Eth}}$   | 3,25                    | 4,00 | 4,75 V                                          |
| Gateladung<br>Gate charge                                                        | $V_{GE} = -15 / 15\text{ V}, V_{CE} = 400\text{ V}$                                                                                                                                                           |                                                                                                   | $Q_G$               | 0,84                    |      | $\mu\text{C}$                                   |
| Interner Gatewiderstand<br>Internal gate resistor                                | $T_{vj} = 25^{\circ}\text{C}$                                                                                                                                                                                 |                                                                                                   | $R_{G\text{int}}$   | 0,0                     |      | $\Omega$                                        |
| Eingangskapazität<br>Input capacitance                                           | $f = 100\text{ kHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$                                                                                                                  |                                                                                                   | $C_{\text{ies}}$    | 14,3                    |      | nF                                              |
| Rückwirkungskapazität<br>Reverse transfer capacitance                            | $f = 100\text{ kHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$                                                                                                                  |                                                                                                   | $C_{\text{res}}$    | 0,05                    |      | nF                                              |
| Kollektor-Emitter-Reststrom<br>Collector-emitter cut-off current                 | $V_{CE} = 650\text{ V}, V_{GE} = 0\text{ V}$                                                                                                                                                                  | $T_{vj} = 25^{\circ}\text{C}$                                                                     | $I_{CES}$           |                         | 1,0  | mA                                              |
| Gate-Emitter-Reststrom<br>Gate-emitter leakage current                           | $V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}, T_{vj} = 25^{\circ}\text{C}$                                                                                                                                      |                                                                                                   | $I_{GES}$           |                         | 100  | nA                                              |
| Einschaltverzögerungszeit, induktive Last<br>Turn-on delay time, inductive load  | $I_C = 100\text{ A}, V_{CE} = 300\text{ V}$<br>$V_{GE} = -15 / 15\text{ V}$<br>$R_{G\text{on}} = 20\text{ }\Omega$                                                                                            | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $t_{d\text{ on}}$   | 0,097<br>0,087<br>0,082 |      | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Anstiegszeit, induktive Last<br>Rise time, inductive load                        | $I_C = 100\text{ A}, V_{CE} = 300\text{ V}$<br>$V_{GE} = -15 / 15\text{ V}$<br>$R_{G\text{on}} = 20\text{ }\Omega$                                                                                            | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $t_r$               | 0,046<br>0,05<br>0,054  |      | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Abschaltverzögerungszeit, induktive Last<br>Turn-off delay time, inductive load  | $I_C = 100\text{ A}, V_{CE} = 300\text{ V}$<br>$V_{GE} = -15 / 15\text{ V}$<br>$R_{G\text{off}} = 39\text{ }\Omega$                                                                                           | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $t_{d\text{ off}}$  | 0,654<br>0,687<br>0,704 |      | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Fallzeit, induktive Last<br>Fall time, inductive load                            | $I_C = 100\text{ A}, V_{CE} = 300\text{ V}$<br>$V_{GE} = -15 / 15\text{ V}$<br>$R_{G\text{off}} = 39\text{ }\Omega$                                                                                           | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $t_f$               | 0,029<br>0,033<br>0,033 |      | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Einschaltverlustenergie pro Puls<br>Turn-on energy loss per pulse                | $I_C = 100\text{ A}, V_{CE} = 300\text{ V}, L\sigma = 35\text{ nH}$<br>$di/dt = 1800\text{ A}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$<br>$V_{GE} = -15 / 15\text{ V}, R_{G\text{on}} = 20\text{ }\Omega$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $E_{\text{on}}$     | 2,79<br>3,20<br>3,51    |      | mJ<br>mJ<br>mJ                                  |
| Abschaltverlustenergie pro Puls<br>Turn-off energy loss per pulse                | $I_C = 100\text{ A}, V_{CE} = 300\text{ V}, L\sigma = 35\text{ nH}$<br>$du/dt = 3700\text{ V}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$<br>$V_{GE} = -15 / 15\text{ V}, R_{G\text{off}} = 39\text{ }\Omega$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $E_{\text{off}}$    | 1,21<br>1,48<br>1,61    |      | mJ<br>mJ<br>mJ                                  |
| Kurzschlußverhalten<br>SC data                                                   | $V_{GE} \leq 15\text{ V}, V_{CC} = 360\text{ V}$<br>$V_{CE\text{ max}} = V_{CES} - L_{SCE} \cdot di/dt$                                                                                                       | $t_P \leq 0\text{ }\mu\text{s}, T_{vj} = 150^{\circ}\text{C}$                                     | $I_{SC}$            | 1600                    |      | A                                               |
| Wärmewiderstand, Chip bis Kühlkörper<br>Thermal resistance, junction to heatsink | pro IGBT / per IGBT                                                                                                                                                                                           |                                                                                                   | $R_{thJH}$          | 0,814                   |      | K/W                                             |
| Temperatur im Schaltbetrieb<br>Temperature under switching conditions            |                                                                                                                                                                                                               |                                                                                                   | $T_{vj\text{ op}}$  | -40                     | 150  | $^{\circ}\text{C}$                              |

**IGBT, T2 / T3 / IGBT, T2 / T3****Höchstzulässige Werte / Maximum Rated Values**

|                                                                          |                                                              |           |       |   |
|--------------------------------------------------------------------------|--------------------------------------------------------------|-----------|-------|---|
| Kollektor-Emitter-Sperrspannung<br>Collector-emitter voltage             | $T_{vj} = 25^{\circ}\text{C}$                                | $V_{CES}$ | 650   | V |
| Implementierter Kollektor-Strom<br>Implemented collector current         |                                                              | $I_{CN}$  | 200   | A |
| Kollektor-Dauergleichstrom<br>Continuous DC collector current            | $T_H = 65^{\circ}\text{C}, T_{vj\max} = 175^{\circ}\text{C}$ | $I_{CDC}$ | 95    | A |
| Periodischer Kollektor-Spitzenstrom<br>Repetitive peak collector current | $t_P = 1\text{ ms}$                                          | $I_{CRM}$ | 400   | A |
| Gate-Emitter-Spitzenspannung<br>Gate-emitter peak voltage                |                                                              | $V_{GES}$ | +/-20 | V |

**Charakteristische Werte / Characteristic Values**

|                                                                                  |                                                                                                                                                                                                               |                                                                                                   | min.                | typ.                    | max.  |                                                 |
|----------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------|---------------------|-------------------------|-------|-------------------------------------------------|
| Kollektor-Emitter-Sättigungsspannung<br>Collector-emitter saturation voltage     | $I_C = 100\text{ A}$<br>$V_{GE} = 15\text{ V}$                                                                                                                                                                | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $V_{CE\text{ sat}}$ | 1,17<br>1,20<br>1,21    | 1,38  | V<br>V<br>V                                     |
| Gate-Schwellenspannung<br>Gate threshold voltage                                 | $I_C = 2,00\text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$                                                                                                                                          |                                                                                                   | $V_{G\text{Eth}}$   | 3,25                    | 4,00  | 4,75 V                                          |
| Gateladung<br>Gate charge                                                        | $V_{GE} = -15 / 15\text{ V}, V_{CE} = 400\text{ V}$                                                                                                                                                           |                                                                                                   | $Q_G$               | 0,84                    |       | $\mu\text{C}$                                   |
| Interner Gatewiderstand<br>Internal gate resistor                                | $T_{vj} = 25^{\circ}\text{C}$                                                                                                                                                                                 |                                                                                                   | $R_{G\text{int}}$   | 0,0                     |       | $\Omega$                                        |
| Eingangskapazität<br>Input capacitance                                           | $f = 100\text{ kHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$                                                                                                                  |                                                                                                   | $C_{\text{ies}}$    | 14,3                    |       | nF                                              |
| Rückwirkungskapazität<br>Reverse transfer capacitance                            | $f = 100\text{ kHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$                                                                                                                  |                                                                                                   | $C_{\text{res}}$    | 0,05                    |       | nF                                              |
| Kollektor-Emitter-Reststrom<br>Collector-emitter cut-off current                 | $V_{CE} = 650\text{ V}, V_{GE} = 0\text{ V}$                                                                                                                                                                  | $T_{vj} = 25^{\circ}\text{C}$                                                                     | $I_{CES}$           |                         | 0,044 | mA                                              |
| Gate-Emitter-Reststrom<br>Gate-emitter leakage current                           | $V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}, T_{vj} = 25^{\circ}\text{C}$                                                                                                                                      |                                                                                                   | $I_{GES}$           |                         | 100   | nA                                              |
| Einschaltverzögerungszeit, induktive Last<br>Turn-on delay time, inductive load  | $I_C = 100\text{ A}, V_{CE} = 300\text{ V}$<br>$V_{GE} = -15 / 15\text{ V}$<br>$R_{G\text{on}} = 20\text{ }\Omega$                                                                                            | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $t_{d\text{ on}}$   | 0,098<br>0,087<br>0,085 |       | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Anstiegszeit, induktive Last<br>Rise time, inductive load                        | $I_C = 100\text{ A}, V_{CE} = 300\text{ V}$<br>$V_{GE} = -15 / 15\text{ V}$<br>$R_{G\text{on}} = 20\text{ }\Omega$                                                                                            | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $t_r$               | 0,037<br>0,043<br>0,046 |       | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Abschaltverzögerungszeit, induktive Last<br>Turn-off delay time, inductive load  | $I_C = 100\text{ A}, V_{CE} = 300\text{ V}$<br>$V_{GE} = -15 / 15\text{ V}$<br>$R_{G\text{off}} = 39\text{ }\Omega$                                                                                           | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $t_{d\text{ off}}$  | 0,651<br>0,685<br>0,695 |       | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Fallzeit, induktive Last<br>Fall time, inductive load                            | $I_C = 100\text{ A}, V_{CE} = 300\text{ V}$<br>$V_{GE} = -15 / 15\text{ V}$<br>$R_{G\text{off}} = 39\text{ }\Omega$                                                                                           | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $t_f$               | 0,018<br>0,024<br>0,026 |       | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Einschaltverlustenergie pro Puls<br>Turn-on energy loss per pulse                | $I_C = 100\text{ A}, V_{CE} = 300\text{ V}, L\sigma = 35\text{ nH}$<br>$di/dt = 2200\text{ A}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$<br>$V_{GE} = -15 / 15\text{ V}, R_{G\text{on}} = 20\text{ }\Omega$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $E_{\text{on}}$     | 2,18<br>2,56<br>2,79    |       | mJ<br>mJ<br>mJ                                  |
| Abschaltverlustenergie pro Puls<br>Turn-off energy loss per pulse                | $I_C = 100\text{ A}, V_{CE} = 300\text{ V}, L\sigma = 35\text{ nH}$<br>$du/dt = 3500\text{ V}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$<br>$V_{GE} = -15 / 15\text{ V}, R_{G\text{off}} = 39\text{ }\Omega$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $E_{\text{off}}$    | 1,28<br>1,65<br>1,80    |       | mJ<br>mJ<br>mJ                                  |
| Kurzschlußverhalten<br>SC data                                                   | $V_{GE} \leq 15\text{ V}, V_{CC} = 360\text{ V}$<br>$V_{CE\text{ max}} = V_{CES} - L_{SCE} \cdot di/dt$                                                                                                       | $t_P \leq 0\text{ }\mu\text{s}, T_{vj} = 150^{\circ}\text{C}$                                     | $I_{SC}$            | 1600                    |       | A                                               |
| Wärmewiderstand, Chip bis Kühlkörper<br>Thermal resistance, junction to heatsink | pro IGBT / per IGBT                                                                                                                                                                                           |                                                                                                   | $R_{th\text{JH}}$   | 0,814                   |       | K/W                                             |
| Temperatur im Schaltbetrieb<br>Temperature under switching conditions            |                                                                                                                                                                                                               |                                                                                                   | $T_{vj\text{ op}}$  | -40                     | 150   | $^{\circ}\text{C}$                              |

**Diode, D1 / D4 / Diode, D1 / D4****Höchstzulässige Werte / Maximum Rated Values**

|                                                                |                                                                                                                                              |           |            |                                              |
|----------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------|-----------|------------|----------------------------------------------|
| Periodische Spitzenspernung<br>Repetitive peak reverse voltage | $T_{vj} = 25^{\circ}\text{C}$                                                                                                                | $V_{RRM}$ | 650        | V                                            |
| Implementierter Durchlassstrom<br>Implemented forward current  |                                                                                                                                              | $I_{FN}$  | 120        | A                                            |
| Dauergleichstrom<br>Continuous DC forward current              |                                                                                                                                              | $I_F$     | 100        | A                                            |
| Periodischer Spitzenstrom<br>Repetitive peak forward current   | $t_P = 1\text{ ms}$                                                                                                                          | $I_{FRM}$ | 240        | A                                            |
| Grenzlastintegral<br>$I^2t$ - value                            | $V_R = 0\text{ V}, t_P = 10\text{ ms}, T_{vj} = 125^{\circ}\text{C}$<br>$V_R = 0\text{ V}, t_P = 10\text{ ms}, T_{vj} = 150^{\circ}\text{C}$ | $I^2t$    | 700<br>690 | $\text{A}^2\text{s}$<br>$\text{A}^2\text{s}$ |

**Charakteristische Werte / Characteristic Values**

|                                                                                  |                                                                                                                                     |                                                                                                   | min.               | typ.                 | max. |                                                 |
|----------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------|--------------------|----------------------|------|-------------------------------------------------|
| Durchlassspannung<br>Forward voltage                                             | $I_F = 100\text{ A}, V_{GE} = 0\text{ V}$<br>$I_F = 100\text{ A}, V_{GE} = 0\text{ V}$<br>$I_F = 100\text{ A}, V_{GE} = 0\text{ V}$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $V_F$              | 1,38<br>1,49<br>1,52 | 1,65 | V<br>V<br>V                                     |
| Rückstromspitze<br>Peak reverse recovery current                                 | $I_F = 100\text{ A}, -di_F/dt = 1800\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 300\text{ V}$                     | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $I_{RM}$           | 58,3<br>74,4<br>77,6 |      | A<br>A<br>A                                     |
| Sperrverzögerungsladung<br>Recovered charge                                      | $I_F = 100\text{ A}, -di_F/dt = 1800\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 300\text{ V}$                     | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $Q_r$              | 3,10<br>5,40<br>5,50 |      | $\mu\text{C}$<br>$\mu\text{C}$<br>$\mu\text{C}$ |
| Abschaltenergie pro Puls<br>Reverse recovery energy                              | $I_F = 100\text{ A}, -di_F/dt = 1800\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 300\text{ V}$                     | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $E_{rec}$          | 0,50<br>0,57<br>0,69 |      | mJ<br>mJ<br>mJ                                  |
| Wärmewiderstand, Chip bis Kühlkörper<br>Thermal resistance, junction to heatsink | pro Diode / per diode                                                                                                               |                                                                                                   | $R_{thJH}$         | 1,15                 |      | K/W                                             |
| Temperatur im Schaltbetrieb<br>Temperature under switching conditions            |                                                                                                                                     |                                                                                                   | $T_{vj\text{ op}}$ | -40                  | 150  | $^{\circ}\text{C}$                              |

**Diode, D2 / D3 / Diode, D2 / D3****Höchstzulässige Werte / Maximum Rated Values**

|                                                                |                                                                                                                                              |           |            |                                              |
|----------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------|-----------|------------|----------------------------------------------|
| Periodische Spitzenspernung<br>Repetitive peak reverse voltage | $T_{vj} = 25^{\circ}\text{C}$                                                                                                                | $V_{RRM}$ | 650        | V                                            |
| Implementierter Durchlassstrom<br>Implemented forward current  |                                                                                                                                              | $I_{FN}$  | 150        | A                                            |
| Dauergleichstrom<br>Continuous DC forward current              |                                                                                                                                              | $I_F$     | 100        | A                                            |
| Periodischer Spitzenstrom<br>Repetitive peak forward current   | $t_P = 1\text{ ms}$                                                                                                                          | $I_{FRM}$ | 300        | A                                            |
| Grenzlastintegral<br>$I^2t$ - value                            | $V_R = 0\text{ V}, t_P = 10\text{ ms}, T_{vj} = 125^{\circ}\text{C}$<br>$V_R = 0\text{ V}, t_P = 10\text{ ms}, T_{vj} = 150^{\circ}\text{C}$ | $I^2t$    | 770<br>690 | $\text{A}^2\text{s}$<br>$\text{A}^2\text{s}$ |

**Charakteristische Werte / Characteristic Values**

|                                                                                  |                                                                                                                                            |                                                                                                   | min.               | typ.                   | max. |                                                 |
|----------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------|--------------------|------------------------|------|-------------------------------------------------|
| Durchlassspannung<br>Forward voltage                                             | $I_F = 100\text{ A}, V_{GE} = 0\text{ V}$<br>$I_F = 100\text{ A}, V_{GE} = 0\text{ V}$<br>$I_F = 100\text{ A}, V_{GE} = 0\text{ V}$        | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $V_F$              | 1,33<br>1,29<br>1,26   | 1,55 | V<br>V<br>V                                     |
| Rückstromspitze<br>Peak reverse recovery current                                 | $I_F = 100\text{ A}, -di_F/dt = 2200\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 300\text{ V}$<br>$V_{GE} = -15\text{ V}$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $I_{RM}$           | 47,6<br>49,8<br>52,7   |      | A<br>A<br>A                                     |
| Sperrverzögerungsladung<br>Recovered charge                                      | $I_F = 100\text{ A}, -di_F/dt = 2200\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 300\text{ V}$<br>$V_{GE} = -15\text{ V}$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $Q_r$              | 1,90<br>2,00<br>2,10   |      | $\mu\text{C}$<br>$\mu\text{C}$<br>$\mu\text{C}$ |
| Abschaltenergie pro Puls<br>Reverse recovery energy                              | $I_F = 100\text{ A}, -di_F/dt = 2200\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 300\text{ V}$<br>$V_{GE} = -15\text{ V}$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $E_{rec}$          | 0,527<br>0,965<br>1,11 |      | mJ<br>mJ<br>mJ                                  |
| Wärmewiderstand, Chip bis Kühlkörper<br>Thermal resistance, junction to heatsink | pro Diode / per diode                                                                                                                      |                                                                                                   | $R_{thJH}$         | 0,953                  |      | K/W                                             |
| Temperatur im Schaltbetrieb<br>Temperature under switching conditions            |                                                                                                                                            |                                                                                                   | $T_{vj\text{ op}}$ | -40                    | 150  | $^{\circ}\text{C}$                              |

**Diode, D5-D6 / Diode, D5-D6****Höchstzulässige Werte / Maximum Rated Values**

|                                                                     |                                                                                                                                                  |           |            |                                              |
|---------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------|-----------|------------|----------------------------------------------|
| Periodische Spitzensperrspannung<br>Repetitive peak reverse voltage | $T_{vj} = 25^{\circ}\text{C}$                                                                                                                    | $V_{RRM}$ | 650        | V                                            |
| Implementierter Durchlassstrom<br>Implemented forward current       |                                                                                                                                                  | $I_{FN}$  | 120        | A                                            |
| Dauergleichstrom<br>Continuous DC forward current                   |                                                                                                                                                  | $I_F$     | 100        | A                                            |
| Periodischer Spitzenstrom<br>Repetitive peak forward current        | $t_p = 1 \text{ ms}$                                                                                                                             | $I_{FRM}$ | 240        | A                                            |
| Grenzlastintegral<br>$I^2t$ - value                                 | $V_R = 0 \text{ V}, t_p = 10 \text{ ms}, T_{vj} = 125^{\circ}\text{C}$<br>$V_R = 0 \text{ V}, t_p = 10 \text{ ms}, T_{vj} = 150^{\circ}\text{C}$ | $I^2t$    | 700<br>690 | $\text{A}^2\text{s}$<br>$\text{A}^2\text{s}$ |

**Charakteristische Werte / Characteristic Values**

|                                                                                  |                                                                                                                                                |                                                                                                   | min.                | typ.                 | max. |                                                 |
|----------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------|---------------------|----------------------|------|-------------------------------------------------|
| Durchlassspannung<br>Forward voltage                                             | $I_F = 100 \text{ A}, V_{GE} = 0 \text{ V}$<br>$I_F = 100 \text{ A}, V_{GE} = 0 \text{ V}$<br>$I_F = 100 \text{ A}, V_{GE} = 0 \text{ V}$      | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $V_F$               | 1,38<br>1,49<br>1,52 | 1,65 | V<br>V<br>V                                     |
| Rückstromspitze<br>Peak reverse recovery current                                 | $I_F = 100 \text{ A}, -di_F/dt = 1800 \text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 300 \text{ V}$<br>$V_{GE} = -15 \text{ V}$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $I_{RM}$            | 58,3<br>74,4<br>77,6 |      | A<br>A<br>A                                     |
| Sperrverzögerungsladung<br>Recovered charge                                      | $I_F = 100 \text{ A}, -di_F/dt = 1800 \text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 300 \text{ V}$<br>$V_{GE} = -15 \text{ V}$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $Q_r$               | 3,10<br>5,40<br>5,50 |      | $\mu\text{C}$<br>$\mu\text{C}$<br>$\mu\text{C}$ |
| Abschaltenergie pro Puls<br>Reverse recovery energy                              | $I_F = 100 \text{ A}, -di_F/dt = 1800 \text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 300 \text{ V}$<br>$V_{GE} = -15 \text{ V}$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $E_{rec}$           | 0,50<br>0,57<br>0,69 |      | mJ<br>mJ<br>mJ                                  |
| Wärmewiderstand, Chip bis Kühlkörper<br>Thermal resistance, junction to heatsink | pro Diode / per diode                                                                                                                          |                                                                                                   | $R_{thJH}$          | 1,15                 |      | K/W                                             |
| Temperatur im Schaltbetrieb<br>Temperature under switching conditions            |                                                                                                                                                |                                                                                                   | $T_{vj \text{ op}}$ | -40                  | 150  | $^{\circ}\text{C}$                              |

**NTC-Widerstand / NTC-Thermistor****Charakteristische Werte / Characteristic Values**

|                                          |                                                                |              | min. | typ. | max. |            |
|------------------------------------------|----------------------------------------------------------------|--------------|------|------|------|------------|
| Nennwiderstand<br>Rated resistance       | $T_{NTC} = 25^{\circ}\text{C}$                                 | $R_{25}$     |      | 5,00 |      | k $\Omega$ |
| Abweichung von R100<br>Deviation of R100 | $T_{NTC} = 100^{\circ}\text{C}, R_{100} = 493 \Omega$          | $\Delta R/R$ | -5   |      | 5    | %          |
| Verlustleistung<br>Power dissipation     | $T_{NTC} = 25^{\circ}\text{C}$                                 | $P_{25}$     |      |      | 20,0 | mW         |
| B-Wert<br>B-value                        | $R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298,15 \text{ K}))]$  | $B_{25/50}$  |      | 3375 |      | K          |
| B-Wert<br>B-value                        | $R_2 = R_{25} \exp [B_{25/80}(1/T_2 - 1/(298,15 \text{ K}))]$  | $B_{25/80}$  |      | 3411 |      | K          |
| B-Wert<br>B-value                        | $R_2 = R_{25} \exp [B_{25/100}(1/T_2 - 1/(298,15 \text{ K}))]$ | $B_{25/100}$ |      | 3433 |      | K          |

Angaben gemäß gültiger Application Note.

Specification according to the valid application note.

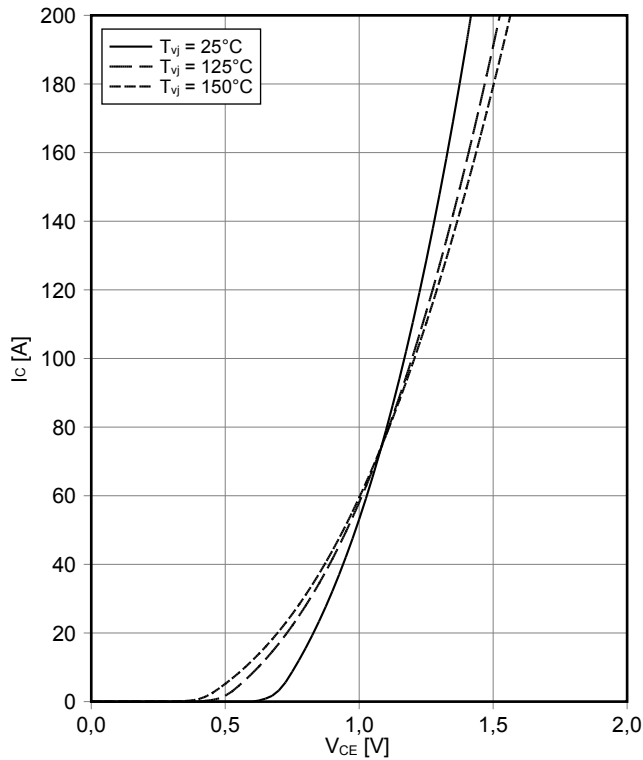
**Modul / Module**

|                                                                   |                                                                                         |                   |                                |      |        |
|-------------------------------------------------------------------|-----------------------------------------------------------------------------------------|-------------------|--------------------------------|------|--------|
| Isolations-Prüfspannung<br>Isolation test voltage                 | RMS, f = 50 Hz, t = 1 min.                                                              | V <sub>ISOL</sub> | 2,5                            | kV   |        |
| Innere Isolation<br>Internal isolation                            | Basisisolierung (Schutzklasse 1, EN61140)<br>basic insulation (class 1, IEC 61140)      |                   | Al <sub>2</sub> O <sub>3</sub> |      |        |
| Kriechstrecke<br>Creepage distance                                | Kontakt - Kühlkörper / terminal to heatsink<br>Kontakt - Kontakt / terminal to terminal |                   | 11,5<br>6,3                    | mm   |        |
| Luftstrecke<br>Clearance                                          | Kontakt - Kühlkörper / terminal to heatsink<br>Kontakt - Kontakt / terminal to terminal |                   | 10,0<br>5,0                    | mm   |        |
| Vergleichszahl der Kriechwegbildung<br>Comperative tracking index |                                                                                         | CTI               | > 200                          |      |        |
| Relativer Temperaturindex (elektr.)<br>RTI Elec.                  | Gehäuse<br>housing                                                                      | RTI               | 140                            | °C   |        |
|                                                                   |                                                                                         |                   |                                |      |        |
|                                                                   |                                                                                         |                   | min.                           | typ. | max.   |
| Modulstreuinduktivität<br>Stray inductance module                 |                                                                                         | L <sub>sCE</sub>  |                                | 20   | nH     |
| Lagertemperatur<br>Storage temperature                            |                                                                                         | T <sub>stg</sub>  | -40                            |      | 125 °C |
| Anpresskraft für mech. Bef. pro Feder<br>mounting force per clamp |                                                                                         | F                 | 40                             | -    | 80 N   |
| Gewicht<br>Weight                                                 |                                                                                         | G                 |                                | 39   | g      |

Der Strom im Dauerbetrieb ist auf 25A effektiv pro Anschlusspin begrenzt.  
The current under continuous operation is limited to 25A rms per connector pin.

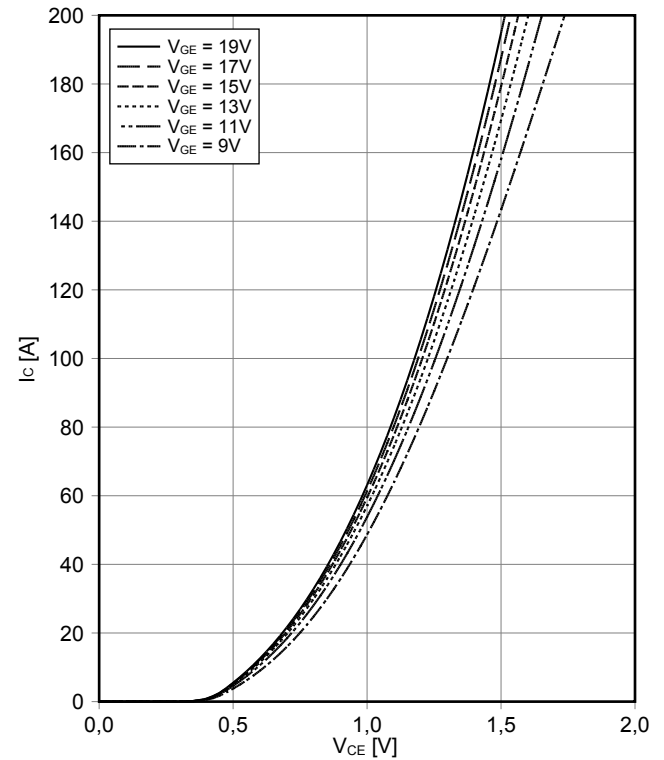
**Ausgangskennlinie IGBT, T1 / T4 (typisch)**  
**output characteristic IGBT, T1 / T4 (typical)**

$I_C = f(V_{CE})$   
 $V_{GE} = 15 \text{ V}$



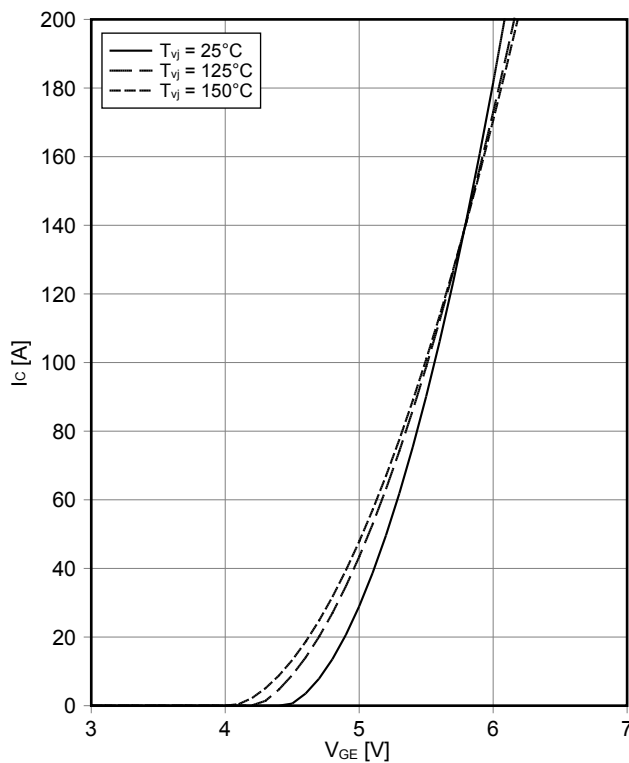
**Ausgangskennlinienfeld IGBT, T1 / T4 (typisch)**  
**output characteristic IGBT, T1 / T4 (typical)**

$I_C = f(V_{CE})$   
 $T_{vj} = 150^\circ\text{C}$



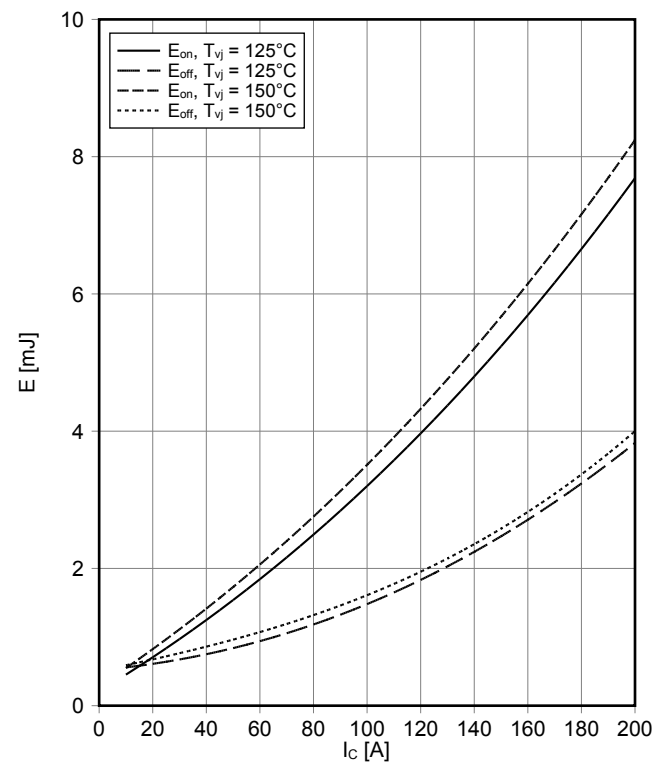
**Übertragungscharakteristik IGBT, T1 / T4 (typisch)**  
**transfer characteristic IGBT, T1 / T4 (typical)**

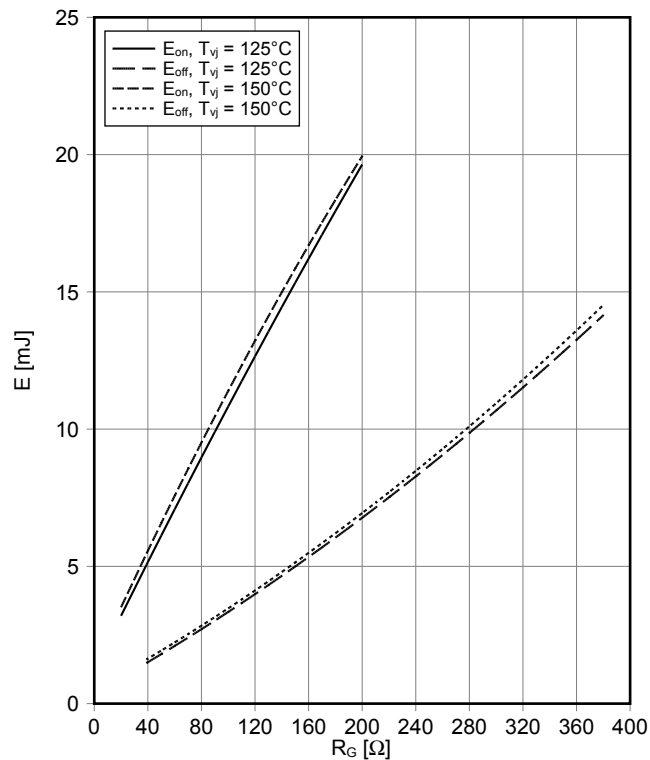
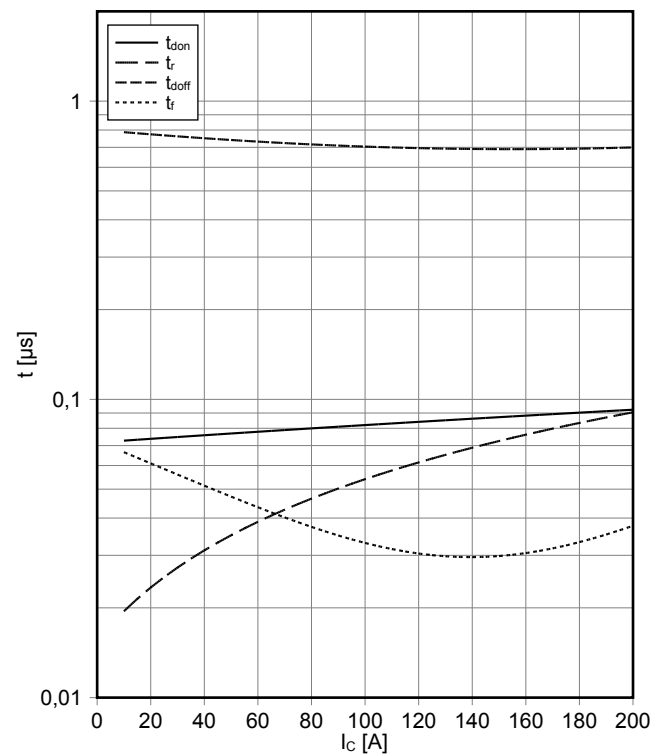
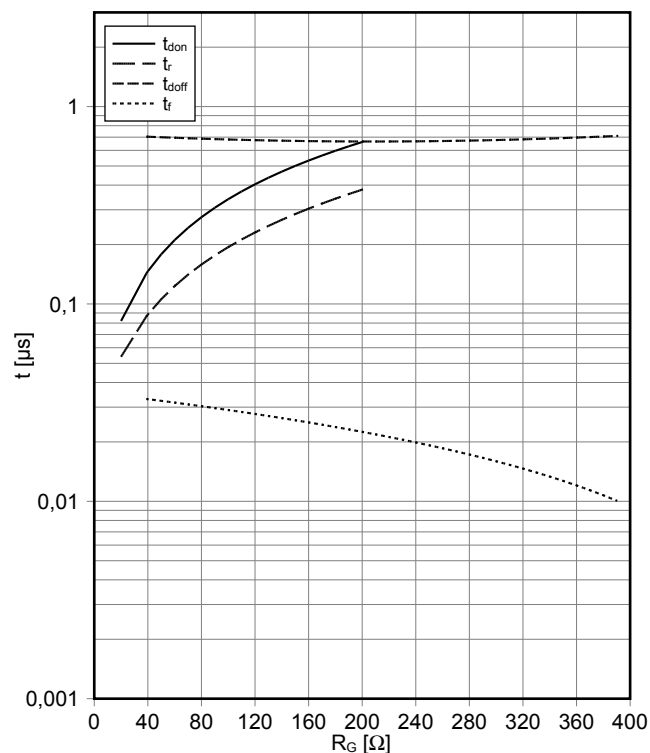
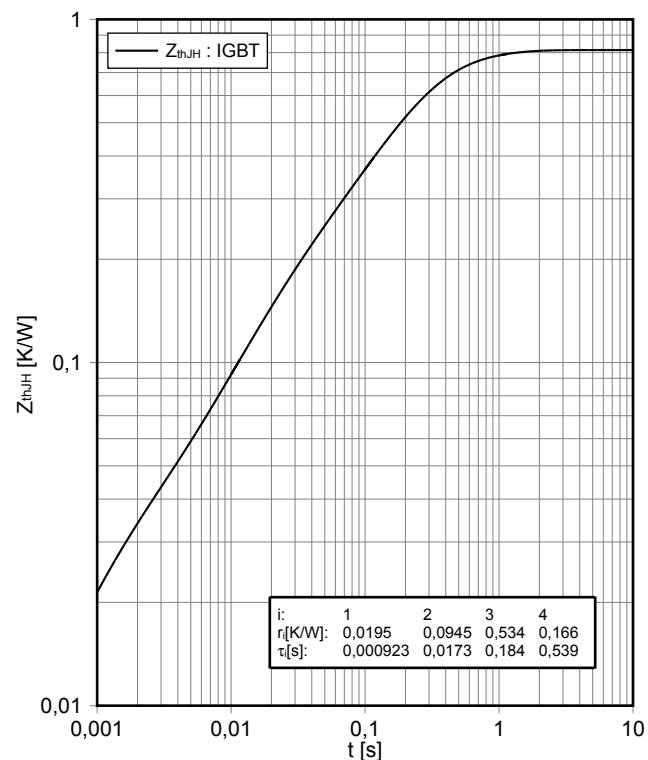
$I_C = f(V_{GE})$   
 $V_{CE} = 20 \text{ V}$



**Schaltverluste IGBT, T1 / T4 (typisch)**  
**switching losses IGBT, T1 / T4 (typical)**

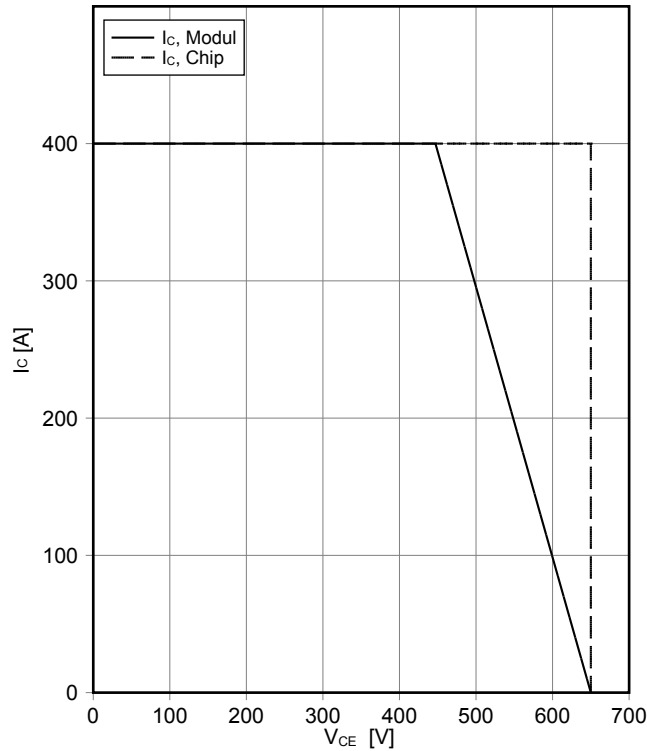
$E_{on} = f(I_C)$ ,  $E_{off} = f(I_C)$   
 $V_{GE} = \pm 15 \text{ V}$ ,  $R_{Gon} = 20 \Omega$ ,  $R_{Goff} = 39 \Omega$ ,  $V_{CE} = 300 \text{ V}$



**Schaltverluste IGBT, T1 / T4 (typisch)**  
**switching losses IGBT, T1 / T4 (typical)**
 $E_{on} = f(R_G), E_{off} = f(R_G)$ 
 $V_{GE} = \pm 15 \text{ V}, I_C = 100 \text{ A}, V_{CE} = 300 \text{ V}$ 

**Schaltzeiten IGBT, T1 / T4 (typisch)**  
**switching times IGBT, T1 / T4 (typical)**
 $t_{don} = f(I_C), t_r = f(I_C), t_{doff} = f(I_C), t_f = f(I_C)$ 
 $V_{GE} = \pm 15 \text{ V}, R_{Gon} = 20 \Omega, R_{Goff} = 39 \Omega, V_{CE} = 300 \text{ V}, T_{vj} = 150^\circ\text{C}$ 

**Schaltzeiten IGBT, T1 / T4 (typisch)**  
**switching times IGBT, T1 / T4 (typical)**
 $t_{don} = f(R_G), t_r = f(R_G), t_{doff} = f(R_G), t_f = f(R_G)$ 
 $V_{GE} = \pm 15 \text{ V}, I_C = 100 \text{ A}, V_{CE} = 300 \text{ V}, T_{vj} = 150^\circ\text{C}$ 

**Transienter Wärmewiderstand IGBT, T1 / T4**  
**transient thermal impedance IGBT, T1 / T4**
 $Z_{thJH} = f(t)$ 


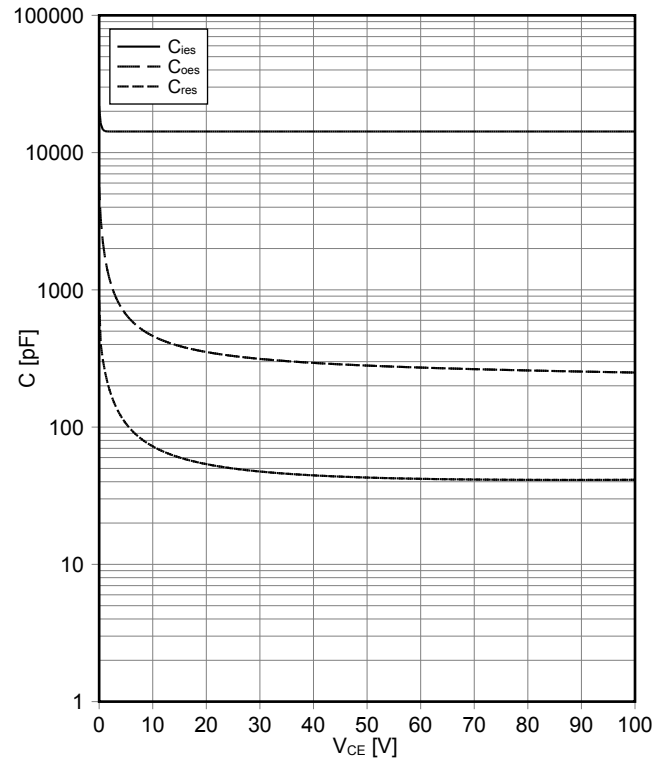
## Sicherer Rückwärts-Arbeitsbereich IGBT, T1 / T4 (RBSOA) reverse bias safe operating area IGBT, T1 / T4 (RBSOA)

$I_C = f(V_{CE})$   
 $V_{GE} = \pm 15 \text{ V}$ ,  $R_{Goff} = 39 \Omega$ ,  $T_{vj} = 150^\circ\text{C}$



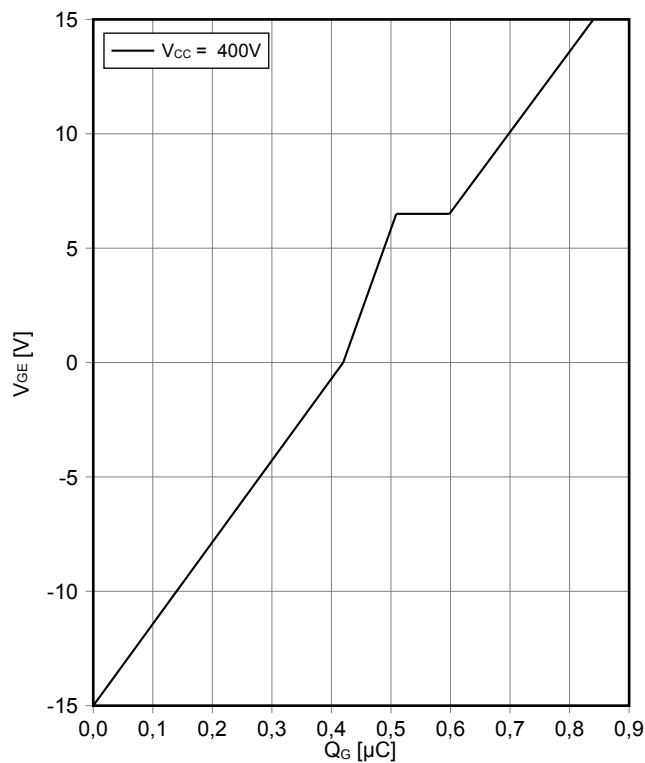
## Kapazitäts Charakteristik IGBT, T1 / T4 (typisch) capacity characteristic IGBT, T1 / T4 (typical)

$C = f(V_{CE})$   
 $V_{GE} = 0 \text{ V}$ ,  $T_{vj} = 25^\circ\text{C}$ ,  $f = 100\text{kHz}$



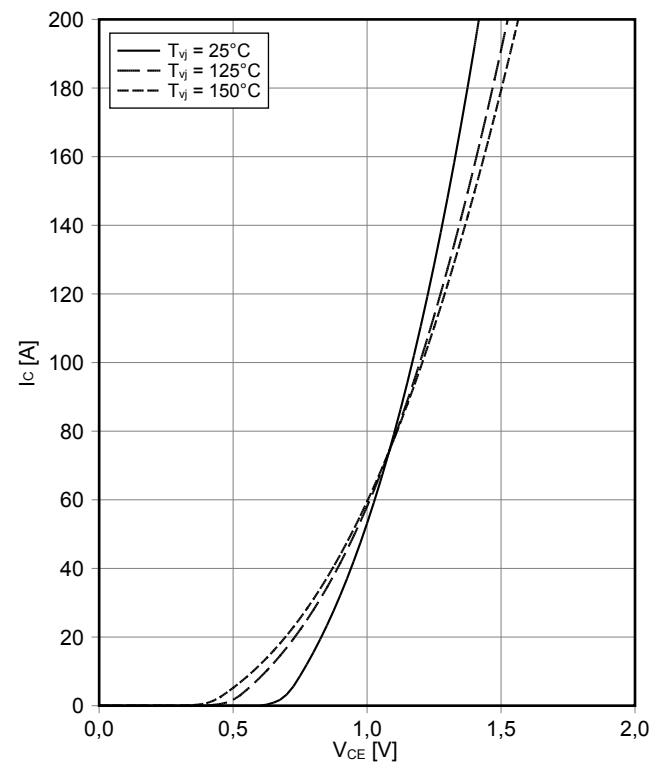
## Gateladungs Charakteristik IGBT, T1 / T4 (typisch) gate charge characteristic IGBT, T1 / T4 (typical)

$V_{GE} = f(Q_G)$   
 $I_C = 200 \text{ A}$ ,  $T_{vj} = 25^\circ\text{C}$



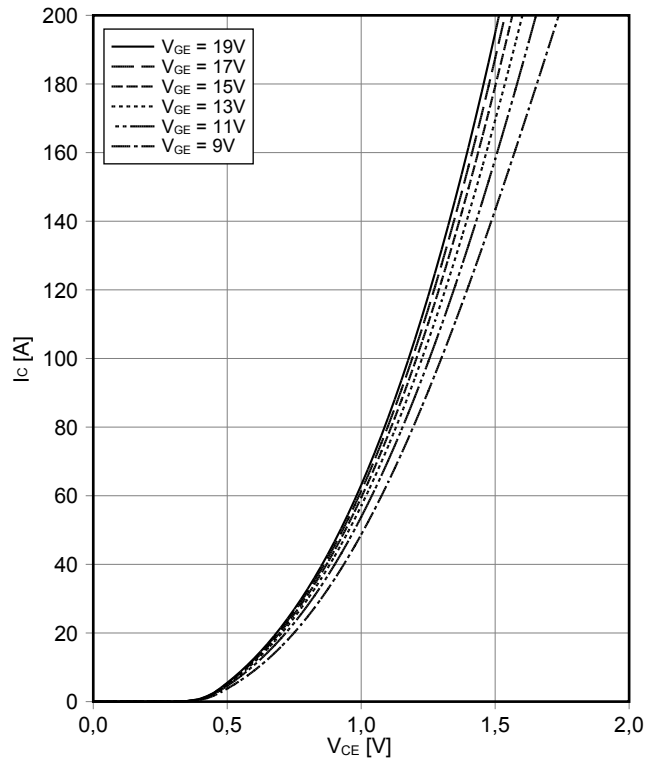
## Ausgangskennlinie IGBT, T2 / T3 (typisch) output characteristic IGBT, T2 / T3 (typical)

$I_C = f(V_{CE})$   
 $V_{GE} = 15 \text{ V}$



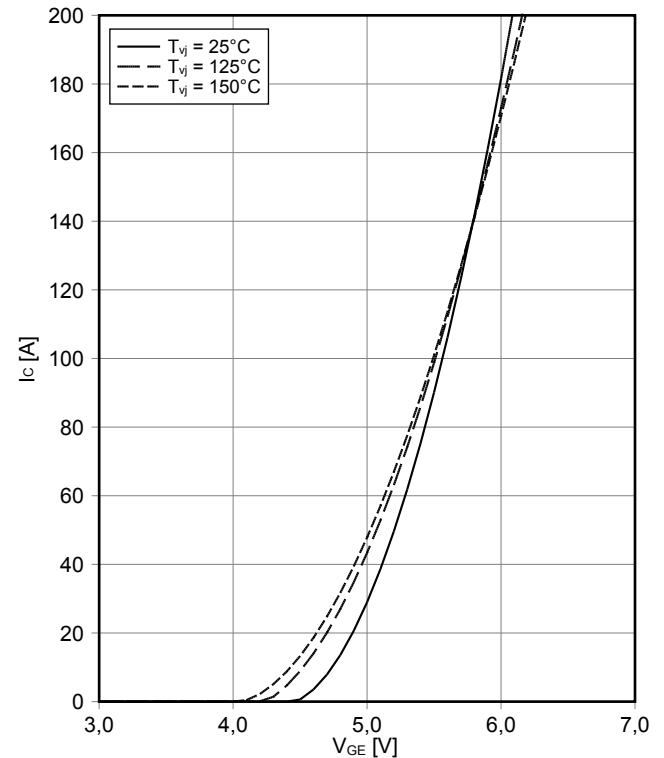
**Ausgangskennlinienfeld IGBT, T2 / T3 (typisch)**  
**output characteristic IGBT, T2 / T3 (typical)**

$I_C = f(V_{CE})$   
 $T_{vj} = 150^\circ\text{C}$



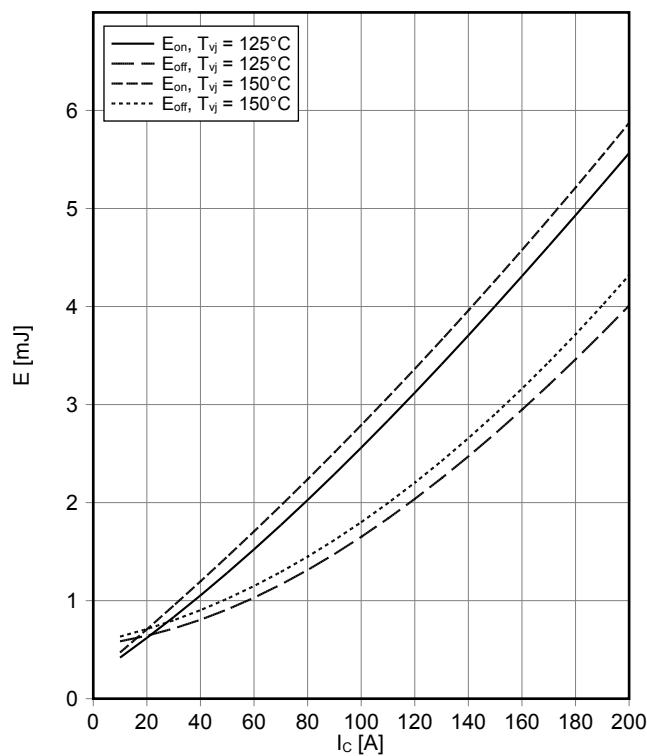
**Übertragungscharakteristik IGBT, T2 / T3 (typisch)**  
**transfer characteristic IGBT, T2 / T3 (typical)**

$I_C = f(V_{GE})$   
 $V_{CE} = 20\text{ V}$



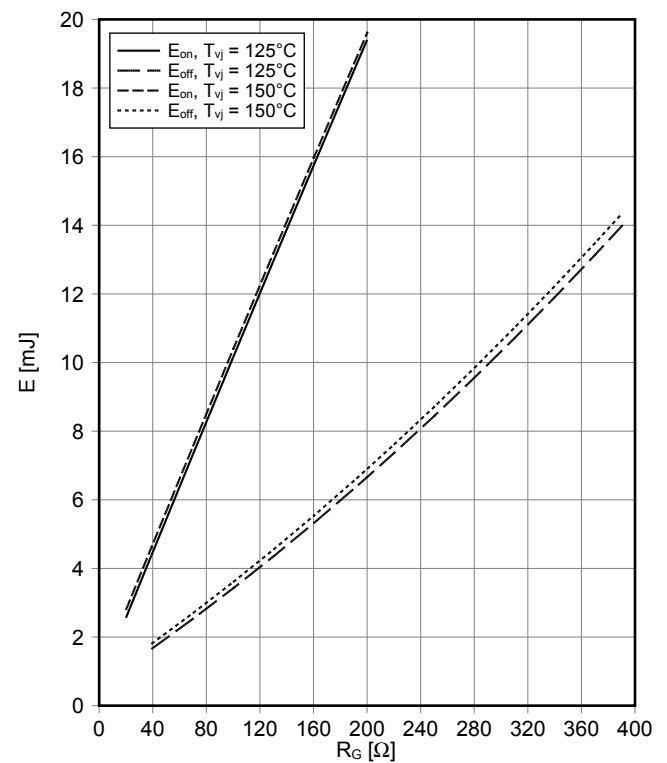
**Schaltverluste IGBT, T2 / T3 (typisch)**  
**switching losses IGBT, T2 / T3 (typical)**

$E_{on} = f(I_C)$ ,  $E_{off} = f(I_C)$   
 $V_{GE} = \pm 15\text{ V}$ ,  $R_{Gon} = 20\ \Omega$ ,  $R_{Goff} = 39\ \Omega$ ,  $V_{CE} = 300\text{ V}$



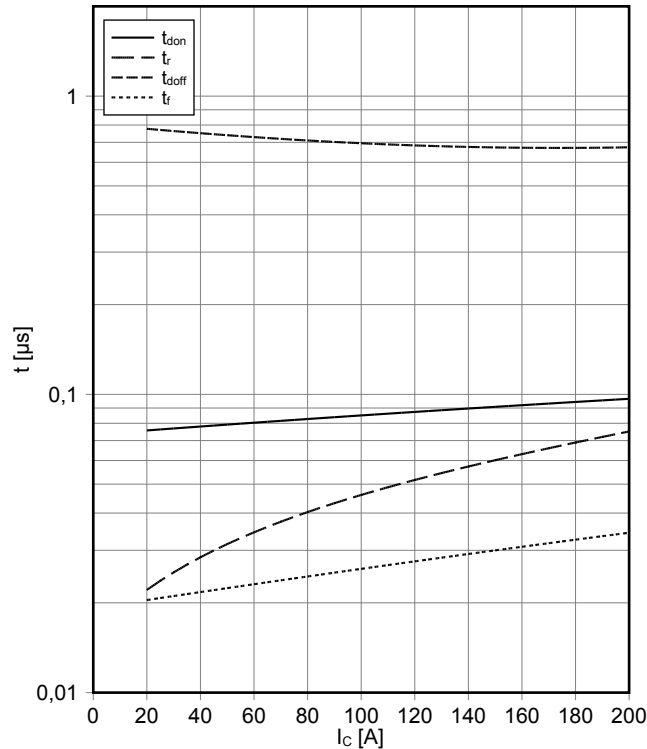
**Schaltverluste IGBT, T2 / T3 (typisch)**  
**switching losses IGBT, T2 / T3 (typical)**

$E_{on} = f(R_G)$ ,  $E_{off} = f(R_G)$   
 $V_{GE} = \pm 15\text{ V}$ ,  $I_C = 100\text{ A}$ ,  $V_{CE} = 300\text{ V}$



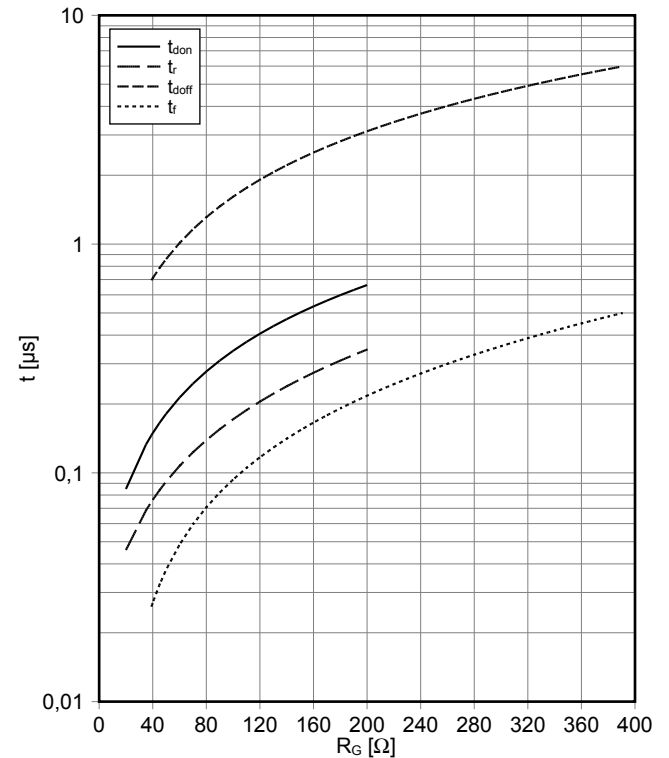
## Schaltzeiten IGBT, T2 / T3 (typisch) switching times IGBT, T2 / T3 (typical)

$t_{don} = f(I_C)$ ,  $t_r = f(I_C)$ ,  $t_{doff} = f(I_C)$ ,  $t_f = f(I_C)$   
 $V_{GE} = \pm 15 \text{ V}$ ,  $R_{Gon} = 20 \Omega$ ,  $R_{Goff} = 39 \Omega$ ,  $V_{CE} = 300 \text{ V}$ ,  $T_{vj} = 150^\circ\text{C}$



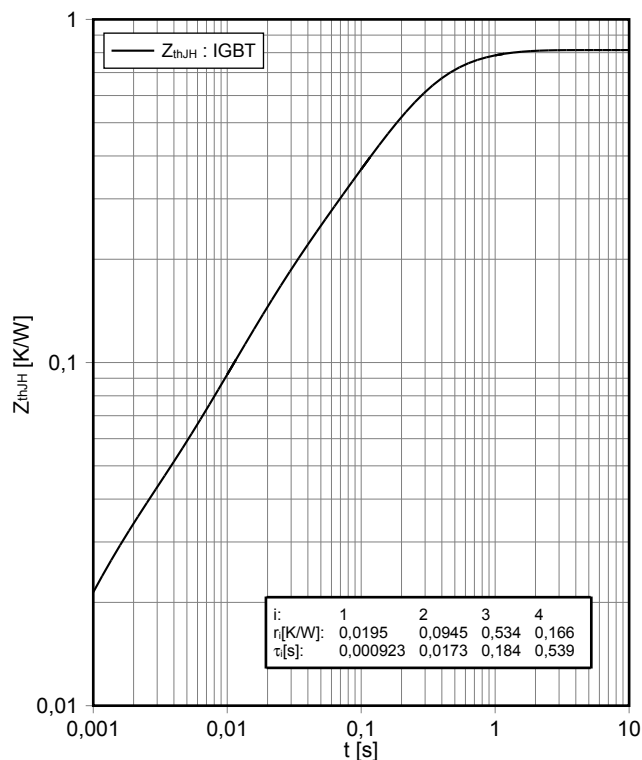
## Schaltzeiten IGBT, T2 / T3 (typisch) switching times IGBT, T2 / T3 (typical)

$t_{don} = f(R_G)$ ,  $t_r = f(R_G)$ ,  $t_{doff} = f(R_G)$ ,  $t_f = f(R_G)$   
 $V_{GE} = \pm 15 \text{ V}$ ,  $I_C = 100 \text{ A}$ ,  $V_{CE} = 300 \text{ V}$ ,  $T_{vj} = 150^\circ\text{C}$



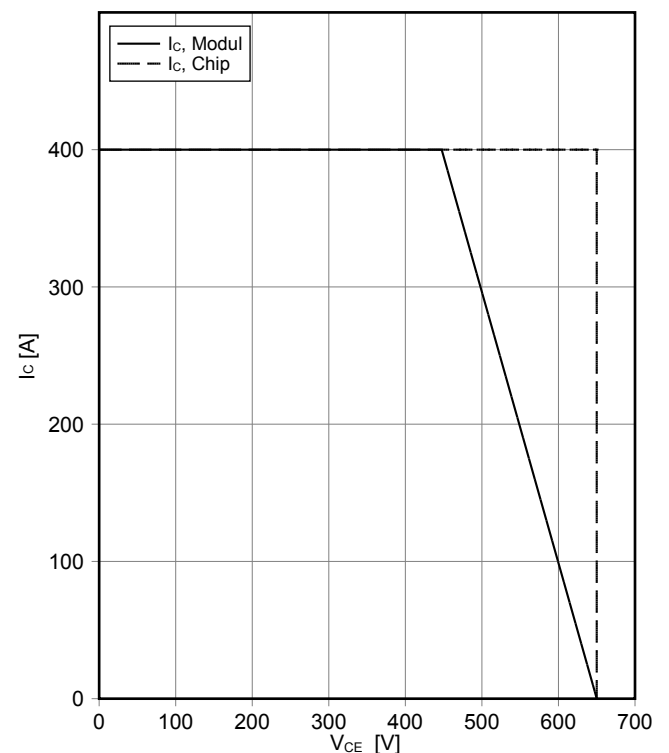
## Transienter Wärmewiderstand IGBT, T2 / T3 transient thermal impedance IGBT, T2 / T3

$Z_{thJH} = f(t)$



## Sicherer Rückwärts-Arbeitsbereich IGBT, T2 / T3 (RBSOA) reverse bias safe operating area IGBT, T2 / T3 (RBSOA)

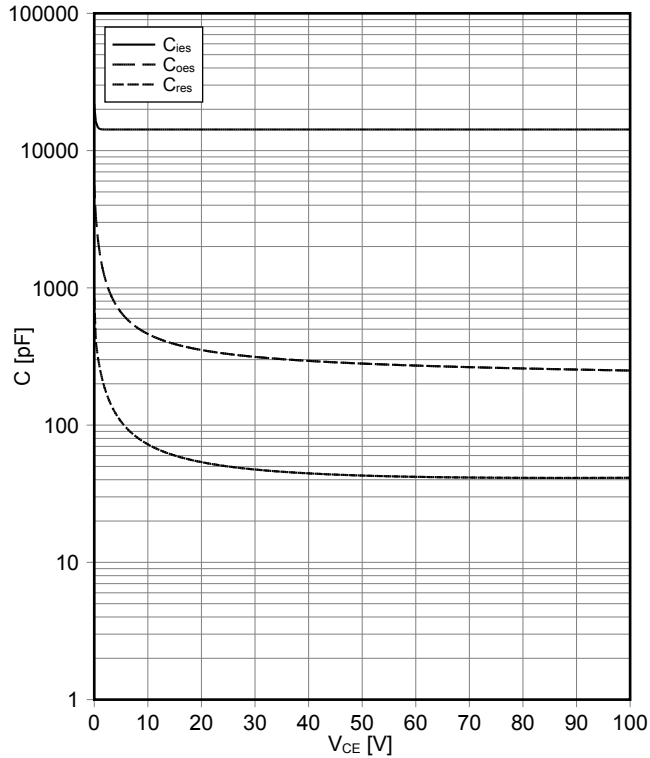
$I_C = f(V_{CE})$   
 $V_{GE} = \pm 15 \text{ V}$ ,  $R_{Goff} = 39 \Omega$ ,  $T_{vj} = 150^\circ\text{C}$



## Kapazitäts Charakteristik IGBT, T2 / T3 (typisch) capacity characteristic IGBT, T2 / T3 (typical)

$$C = f(V_{CE})$$

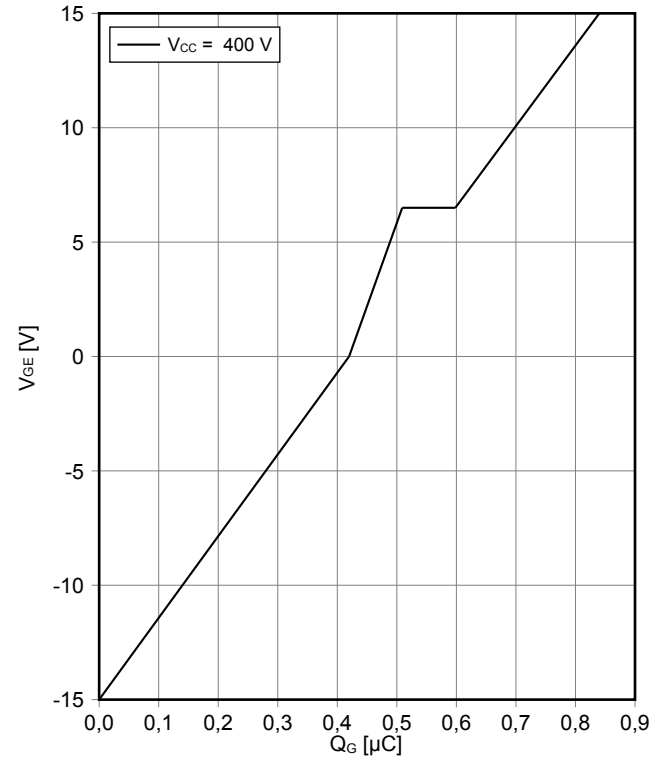
$V_{GE} = 0 \text{ V}$ ,  $T_{vj} = 25^\circ\text{C}$ ,  $f = 100\text{kHz}$



## Gateladungs Charakteristik IGBT, T2 / T3 (typisch) gate charge characteristic IGBT, T2 / T3 (typical)

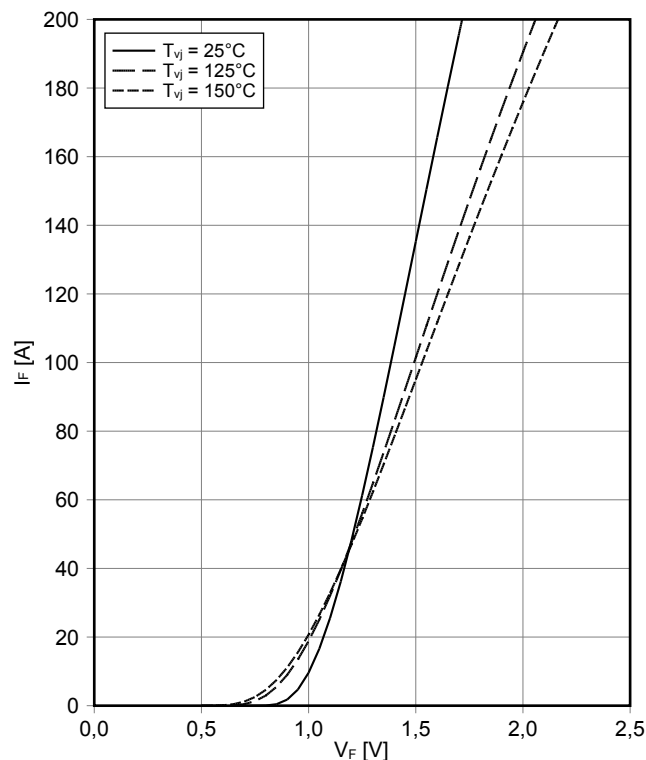
$$V_{GE} = f(Q_G)$$

$I_C = 200 \text{ A}$ ,  $T_{vj} = 25^\circ\text{C}$



## Durchlasskennlinie der Diode, D1 / D4 (typisch) forward characteristic of Diode, D1 / D4 (typical)

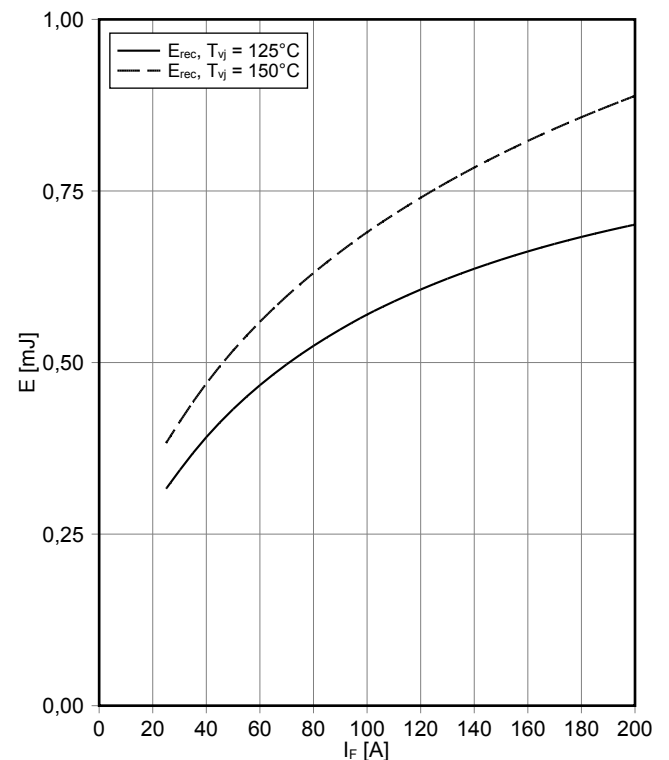
$$I_F = f(V_F)$$

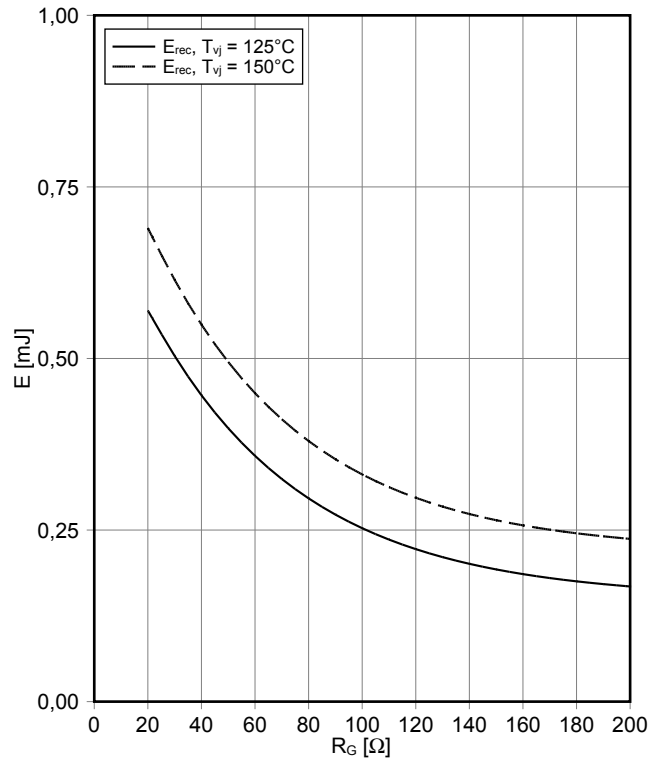
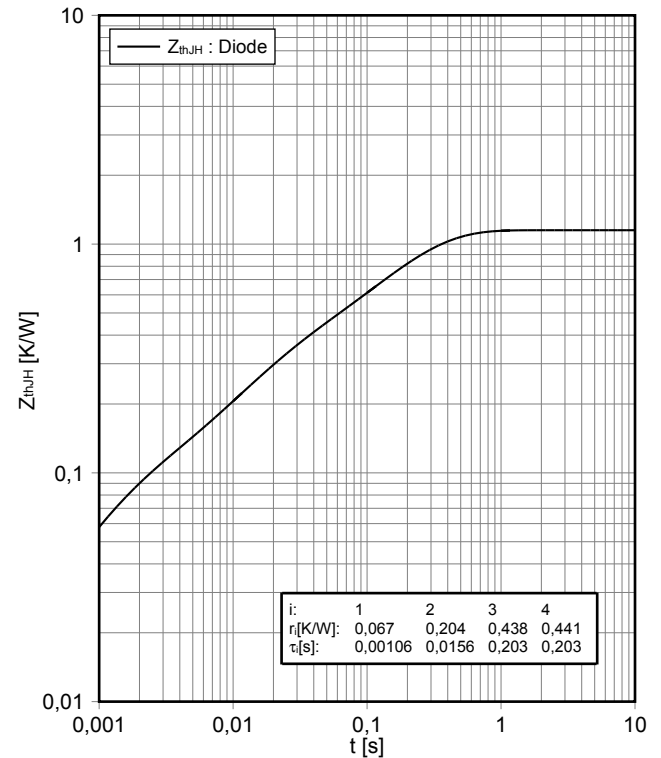
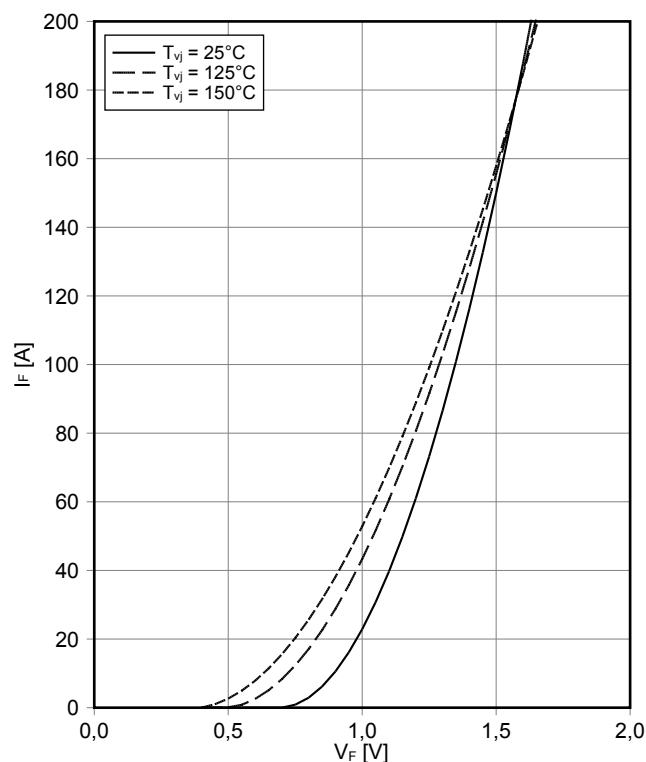
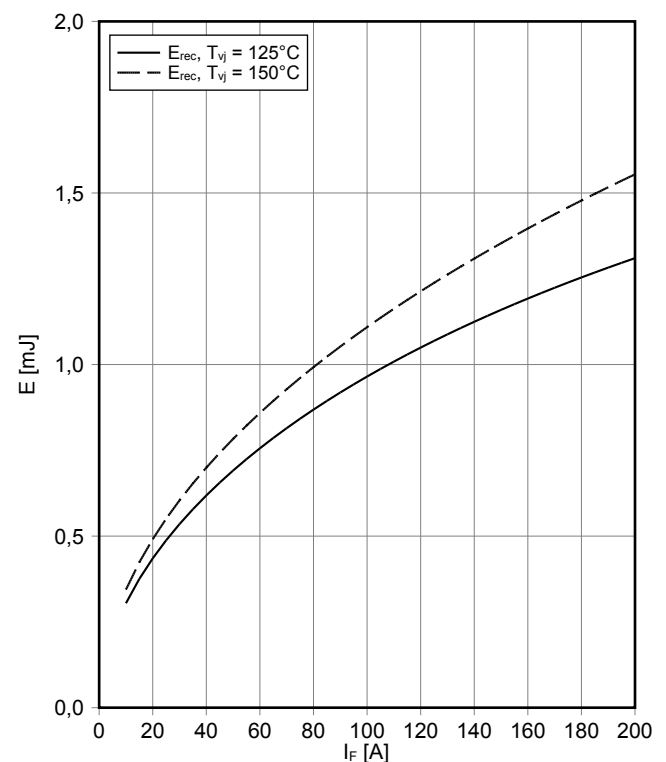


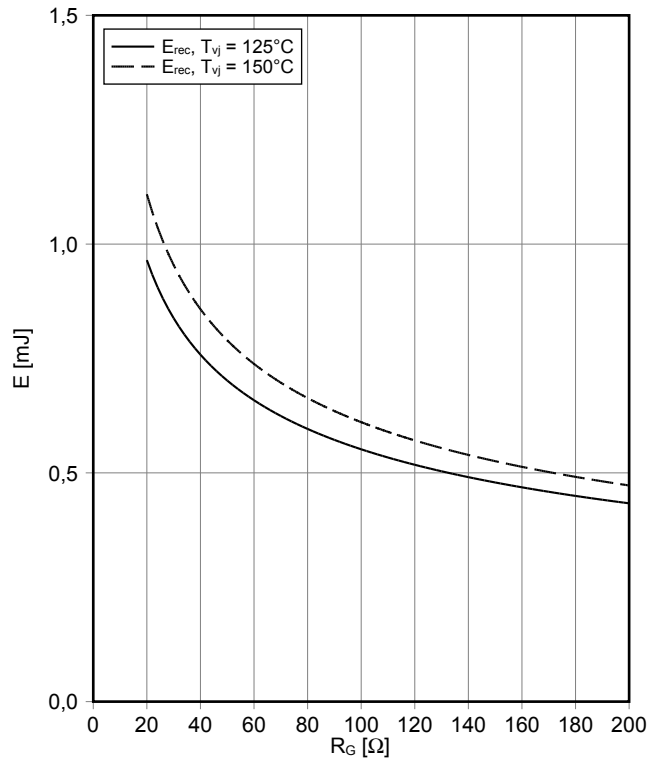
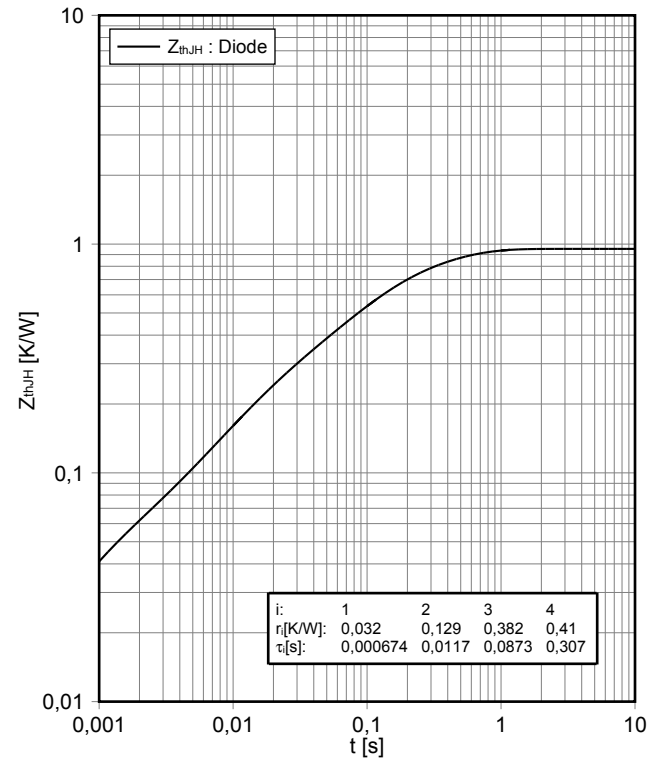
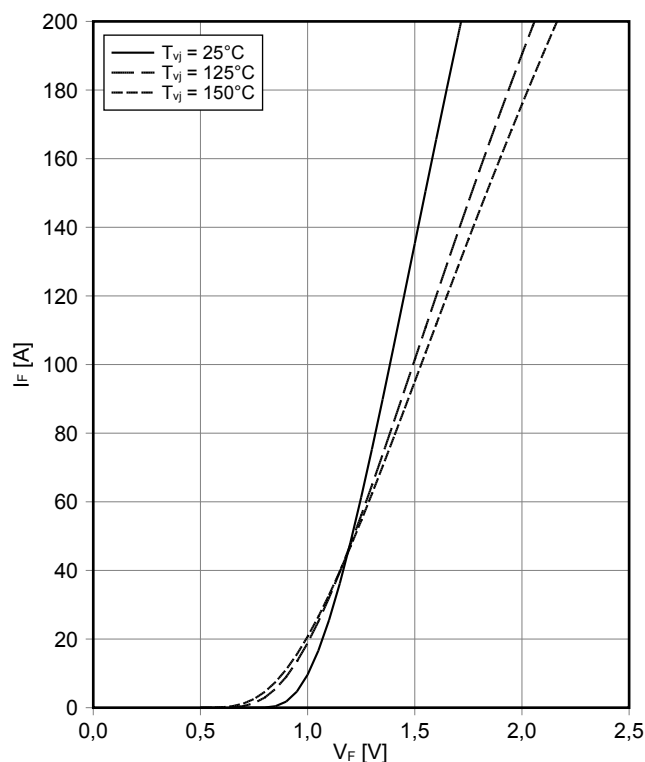
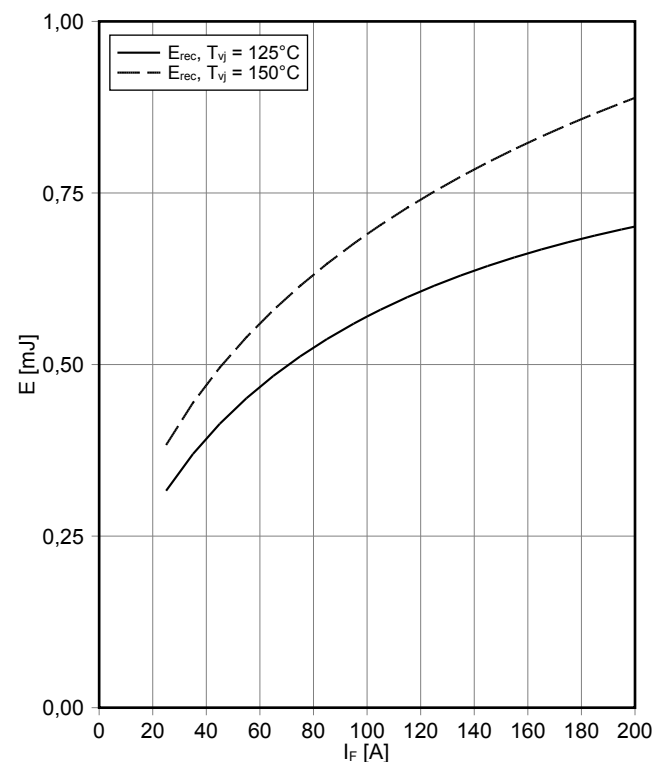
## Schaltverluste Diode, D1 / D4 (typisch) switching losses Diode, D1 / D4 (typical)

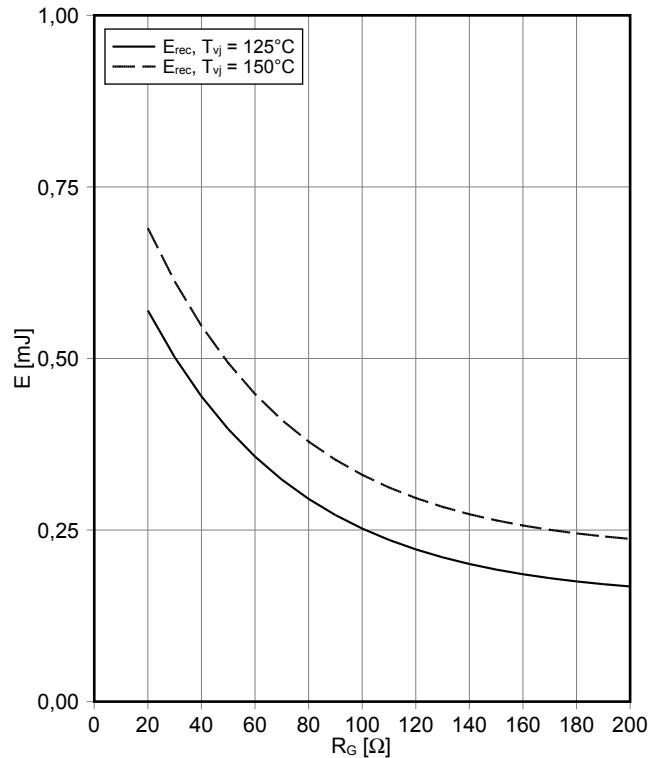
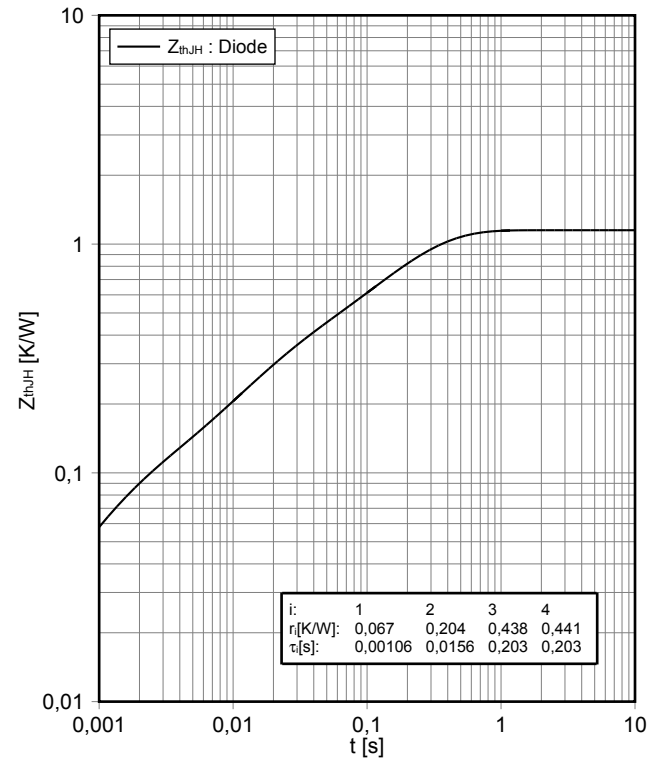
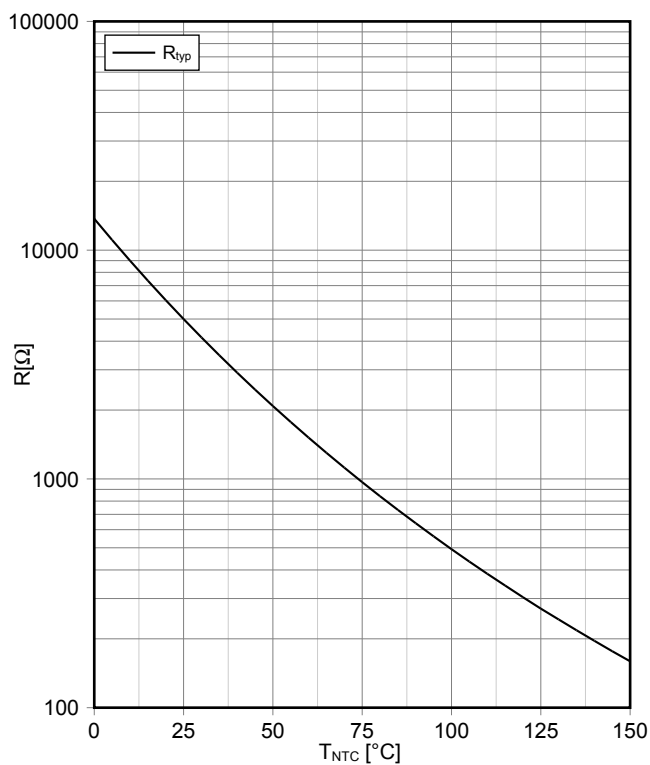
$$E_{rec} = f(I_F)$$

$R_{Gon} = 20 \Omega$ ,  $V_{CE} = 300 \text{ V}$

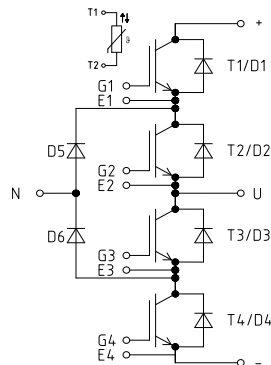


**Schaltverluste Diode, D1 / D4 (typisch)**  
**switching losses Diode, D1 / D4 (typical)**
 $E_{rec} = f(R_G)$   
 $I_F = 100\text{ A}$ ,  $V_{CE} = 300\text{ V}$ 

**Transienter Wärmewiderstand Diode, D1 / D4**  
**transient thermal impedance Diode, D1 / D4**
 $Z_{thJH} = f(t)$ 

**Durchlasskennlinie der Diode, D2 / D3 (typisch)**  
**forward characteristic of Diode, D2 / D3 (typical)**
 $I_F = f(V_F)$ 

**Schaltverluste Diode, D2 / D3 (typisch)**  
**switching losses Diode, D2 / D3 (typical)**
 $E_{rec} = f(I_F)$   
 $R_{Gon} = 20\ \Omega$ ,  $V_{CE} = 300\text{ V}$ 


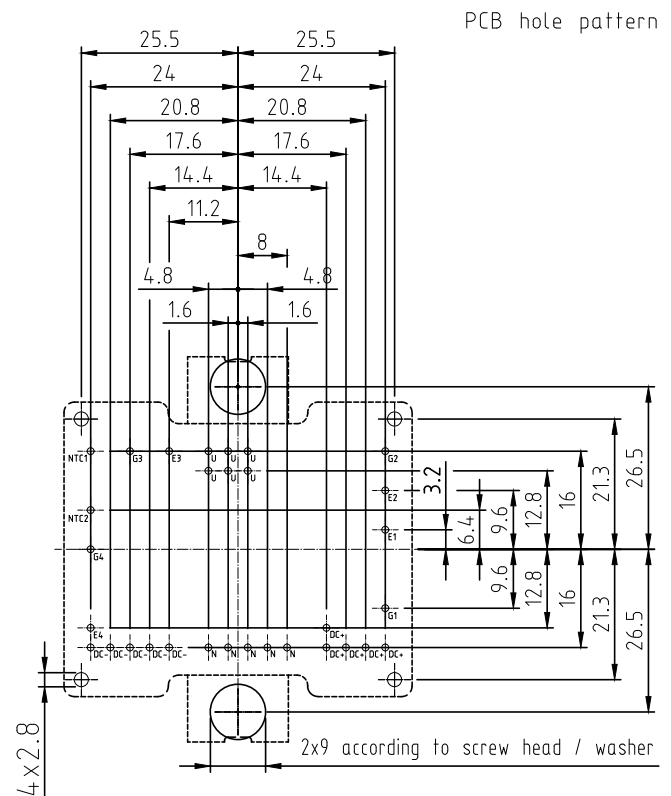
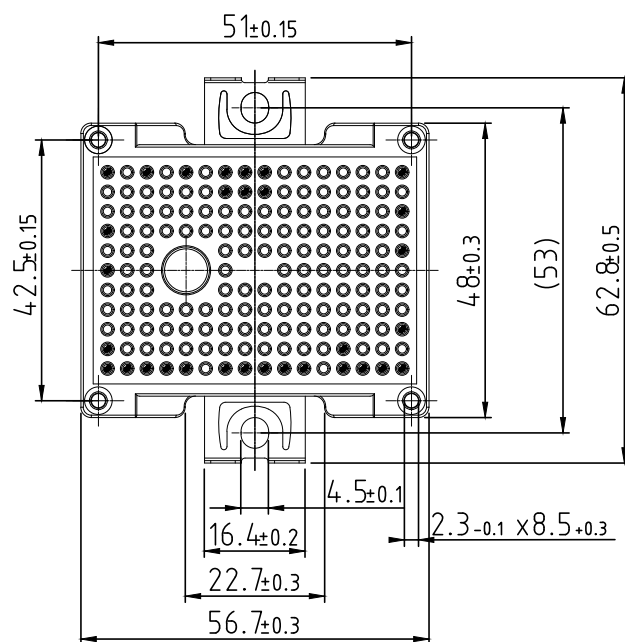
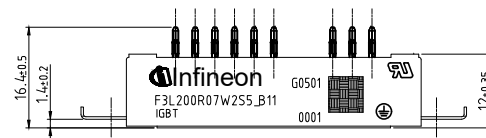
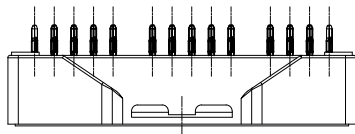
**Schaltverluste Diode, D2 / D3 (typisch)**  
**switching losses Diode, D2 / D3 (typical)**
 $E_{rec} = f(R_G)$   
 $I_F = 100\text{ A}$ ,  $V_{CE} = 300\text{ V}$ 

**Transienter Wärmewiderstand Diode, D2 / D3**  
**transient thermal impedance Diode, D2 / D3**
 $Z_{thJH} = f(t)$ 

**Durchlasskennlinie der Diode, D5-D6 (typisch)**  
**forward characteristic of Diode, D5-D6 (typical)**
 $I_F = f(V_F)$ 

**Schaltverluste Diode, D5-D6 (typisch)**  
**switching losses Diode, D5-D6 (typical)**
 $E_{rec} = f(I_F)$   
 $R_{Gon} = 20\ \Omega$ ,  $V_{CE} = 300\text{ V}$ 


**Schaltverluste Diode, D5-D6 (typisch)**  
**switching losses Diode, D5-D6 (typical)**
 $E_{\text{rec}} = f(R_G)$   
 $I_F = 100 \text{ A}, V_{CE} = 300 \text{ V}$ 

**Transienter Wärmewiderstand Diode, D5-D6**  
**transient thermal impedance Diode, D5-D6**
 $Z_{\text{thJH}} = f(t)$ 

**NTC-Widerstand-Temperaturkennlinie (typisch)**  
**NTC-Thermistor-temperature characteristic (typical)**
 $R = f(T_{\text{NTC}})$ 


## Schaltplan / Circuit diagram



## Gehäuseabmessungen / Package outlines



- Pin-Grid 3.2mm
- Tolerance of PCB hole pattern  $\pm 0.1$
- Hole specification for contacts see AN 2009-01:  
Diameters of drill  $\phi 1.15\text{mm}$   
and copper thickness in hole 25-50 $\mu\text{m}$

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